JNIC



## High-Speed USB 2.0 (480-Mbps) 1:2 Multiplexer/Demultiplexer Switch

## FEATURES

- -3dB Bandwidth: 550MHz
- Supply Range: +1.8V to +5.5V
- R<sub>ON</sub> is Typically 6Ω
- Fast Switching Times: t<sub>ON</sub> 20ns t<sub>OFF</sub> 15ns
- Break-Before-Make Switching
- Low Power Consumption (1uA Maximum)
- Rail-to-Rail Input and Output Operation
- Extended Industrial Temperature Range: -40°C to +85°C
- Micro SIZE PACKAGES: UQFN1.4X1.8-10, MSOP10

## DESCRIPTION

The RS2228 is a high-speed, low-power double-pole/double-throw (DPDT) analog switch with single Enable. It is designed to operate from 1.8 V to 5.5 V.

The RS2228 has a bus-switch enable pin,  $\overline{OE}$ , that can place the signal paths in high impedance. This allows the user to isolate the bus when it is not in use and consume less current.

The RS2228 is a high-bandwidth switch specially designed for the switching of high-speed USB2.0 signals in handset and consumer applications, such as cell phones, digital cameras, and notebooks with hubs or controllers with limited USB I/Os.

The RS2228 is available UQFN1.4X1.8-10 and MSOP10 package. It operates over an ambient temperature range of -40°C to +85°C.

## APPLICATIONS

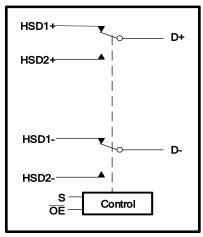
- Routes Signals for USB 1.0, 1.1, and 2.0
- MP3 and Other Personal Media Players
- Portable Instrumentation
- USB Switching
- Digital Cameras
- Set-Top Box
- Cell Phones
- PDAs

#### **Device Information**<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
RS2228	UQFN1.4X1.8-10	1.80mm×1.40mm
	MSOP10	3.00mm×3.00mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

#### **Functional Block Diagram**





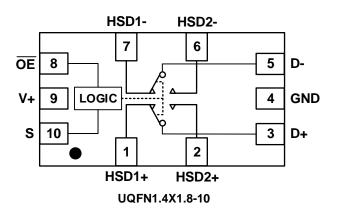
**Revision History** Note: Page numbers for previous revisions may different from page numbers in the current version.

Version	Change Date	Change Item
C.1	2021/07/06	Changed UQFN1.4X1.8-10 Package Marking in Page 5@B.4 Version
C.1.1	2024/03/11	1. Added the TAPE AND REEL INFORMATION 2. Modify packaging naming



## **PIN CONFIGURATIONS**





#### **PIN DESCRIPTION**

NAME	PIN	FUNCTION
V+	9	Power Supply
GND	4	Ground
S	10	Select Input
OE	8	Output Enable
HSD1+, HSD2+	1,2	
HSD1-, HSD2-	7,6	Data Port
D+, D-	3,5	

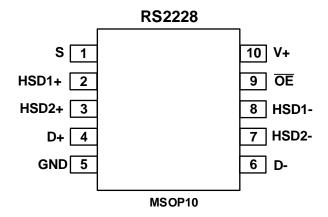
### **FUNCTION TABLE**

ŌĒ	S	HSD1+, HSD1-	HSD2+, HSD2-
0	0	ON	OFF
0	1	OFF	ON
1	Х	OFF	OFF

Note: X =Don't care



## **PIN CONFIGURATIONS**



#### **PIN DESCRIPTION**

NAME	PIN	FUNCTION
V+	10	Power Supply
GND	5	Ground
S	1	Select Input
OE	9	Output Enable
HSD1+, HSD2+	2,3	
HSD1-, HSD2-	8,7	Data Port
D+, D-	4,6	

### **FUNCTION TABLE**

ŌĒ	S	HSD1+, HSD1-	HSD2+, HSD2-
0	0	ON	OFF
0	1	OFF	ON
1	Х	OFF	OFF

Note: X =Don't care



## SPECIFICATIONS

#### **Absolute Maximum Ratings**

Over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

SYMBOL	PARAMETER	MIN	МАХ	UNIT
V+	Supply Voltage	-0.3	6.0	V
	Analog, Digital Voltage Range <sup>(2)</sup>	-0.3	(V <sub>+</sub> )+0.3	v
	Continuous Current HSDn or Dn	-100	+100	٣A
IPEAK	Peak Current HSDn or Dn	-150	+150 mA	
TJ	Junction Temperature	-40	150	°C
T <sub>stg</sub>	Storage temperature	-65	+150	

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.3V beyond the supply rails should be current-limited to 10mA or less.

#### **ESD** Ratings

			VALUE	UNIT
V(ESD) Electrostatic discharge	Electrostatic discharge	Human-body model (HBM)	±3000	V
	Machine Model (MM)	±200	V	

#### **Recommended Operating Conditions**

Over operating free-air temperature range (unless otherwise noted)

SYMBOL	PARAMETER	MIN	МАХ	UNIT
Vcc	Supply Voltage	1.8	5.5	V
TA	Operating temperature	-40	+85	°C

#### **Thermal Information**

			RS2228			
	THERMAL METRIC	1	UNIT			
		MSOP10	UQFN1.4X1.8-10			
Reja	Junction-to-ambient thermal resistance	180.7	120	°C/W		
ReJC(top)	Junction-to-case(top) thermal resistance	66.2	46.0	°C/W		
R <sub>ejb</sub>	Junction-to-board thermal resistance	103.2	44.5	°C/W		
$\Psi_{JT}$	Junction-to-top characterization parameter	11.2	1.5	°C/W		
$\psi_{JB}$	Junction-to-board characterization parameter	101.3	44.5	°C/W		
ReJC(bot)	Junction-to-case(bottom) thermal resistance	N/A	31.2	°C/W		



## **PACKAGE/ORDERING INFORMATION**

PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING <sup>(1)</sup>	PACKAGE OPTION
RS2228	RS2228XN	-40°C ~+85°C	MSOP10	RS2228	Tape and Reel,4000
	RS2228XUTQK10	-40°C ~+85°C	UQFN1.4X1.8-10	2228	Tape and Reel,4000

NOTE:

(1) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.



## **ELECTRICAL CHARACTERISTICS**

 $(V_{+} = +1.8V \text{ to } +5.5V, \text{GND} = 0V, V_{IH} = +1.5V, V_{IL} = +0.5V, T_{A} = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}$ . Typical values are at V+ = +3.3V, T\_{A} = +25^{\circ}\text{C}, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	ТҮР	МАХ	UNIT	
ANALOG SWITCH								
Analog I/O Voltage (HSD1+, HSD1-, HSD2+, HSD2-)	Vis		-40°C to +85°C	0		V+	V	
On-Resistance	<b>D</b>	V+ = 3.0V, V <sub>IS</sub> = 0V to 0.4V,	+25°C		6	10		
	Ron	$I_D$ = 8mA, See Figure 1	-40°C to +85°C			10.5	Ω	
On-Resistance Match		V+ = 3.0V, V <sub>IS</sub> = 0V to 0.4V,	+25°C		0.15	0.6	Ω	
Between Channels	$\Delta R_{ON}$	$I_D$ = 8mA, See Figure 1	-40°C to +85°C			1.6	Ω	
	R <sub>FLAT(ON)</sub>	V+ = 3.0V, V <sub>IS</sub> = 0V to 1.0V,	+25°C		5	7		
On-Resistance Flatness		$I_D = 8mA$ , See Figure 1	-40°C to +85°C			8	Ω	
Power Off Leakage Current (D+, D-)	I <sub>OFF</sub>	V+ = 0V, V <sub>D</sub> = 0V to 3.6 V, V <sub>S</sub> , V <sub>OE</sub> = 0V or 3.6 V	-40°C to +85°C			1	uA	
Increase in I+per Control Voltage	Ісст	V+ = 3.6V, V <sub>S</sub> or $V_{\overline{OE}}$ = 2.6 V	-40°C to +85°C			40	uA	
Source Off Leakage Current	HSD2(OFF)	V+ = 3.6V, V <sub>IS</sub> = 3.3V/ 0.3V, V <sub>D</sub> = 0.3V/ 3.3V	-40°C to +85°C			1	uA	
Channel On Leakage Current	HSD2(ON)	V+ = 3.6V, $V_{IS}$ = 3.3V/ 0.3V, V <sub>D</sub> = 0.3V/ 3.3V or floating	-40°C to +85°C			1	uA	
DIGITAL CONTROL INPUTS <sup>(1</sup>	DIGITAL CONTROL INPUTS <sup>(1)</sup>							
Input High Voltage	V <sub>IH</sub>		-40°C to +85°C	1.6			V	
Input Low Voltage	VIL		-40°C to +85°C			0.5	V	
Input Leakage Current	lin	V+ = 3.0V, V <sub>S</sub> , $V_{\overline{OE}}$ = 0V or V+	-40°C to +85°C			1	uA	

(1) All unused digital inputs of the device must be held at  $V_{IO}$  or GND to ensure proper device operation.

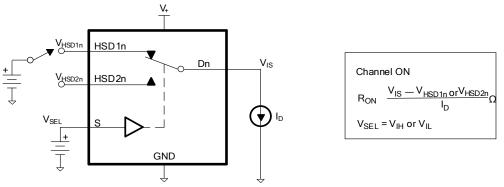


**ELECTRICAL CHARACTERISTICS (continued)** (V+ = +1.8V to +5.5V, GND = 0V, V<sub>IH</sub> = +1.5V, V<sub>IL</sub> = +0.5V, T<sub>A</sub> = -40°C to + 85°C. Typical values are at V+ = +3.3V, T<sub>A</sub> = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TA	MIN	ТҮР	MAX	UNIT		
DYNAMIC CHARACTERISTICS									
Turn-On Time	tоn	V <sub>IS</sub> = 0.8V, R <sub>L</sub> = 50Ω,	+25°C		20		ns		
Turn-Off Time	toff	C∟ = 10pF, See Figure 2	+25°C		15		ns		
Break-Before-Make Time Delay	t <sub>D</sub>	$V_{IS} = 0.8V$ , $R_L = 50\Omega$ , $C_L = 10pF$ , See Figure 3	+25°C		4		ns		
Propagation Delay	t <sub>PD</sub>	R <sub>L</sub> = 50Ω, C <sub>L</sub> = 10pF	+25°C		0.35		ns		
Off Isolation	Oiso	Signal = 0dBm, R∟ = 50Ω, f = 250MHz, See Figure 4	+25°C		-35		dB		
Channel-to-Channel Crosstalk	X <sub>TALK</sub>	Signal = 0dBm, R∟ = 50Ω, f = 250MHz, See Figure 5	+25°C		-40		dB		
-3dB Bandwidth	BW	Signal = 0dBm, R∟ = 50Ω, C∟ = 5pF, See Figure 6	+25°C		550		MHz		
Channel-to-Channel Skew	t <sub>skew</sub>	R <sub>L</sub> = 50Ω, C <sub>L</sub> = 10pF	+25°C		0.05		ns		
Charge Injection Select Input to Common I/O	Q	$V_G = GND, C_L = 1.0nF, R_G = 0\Omega,$ Q = C <sub>L</sub> x V <sub>OUT</sub> , See Figure 7	+25°C		11		рС		
HSD+, HSD-, D+, D- ON Capacitance	Сол		+25°C		7		pF		
POWER REQUIREMENTS									
Power Supply Range	V+		-40°C to +85°C	1.8		5.5	V		
Power Supply Current	I+	V+ = 3.0V, V <sub>S</sub> , $V_{\overline{OE}}$ = 0V or V+	-40°C to +85°C			1	uA		



## **Parameter Measurement Information**





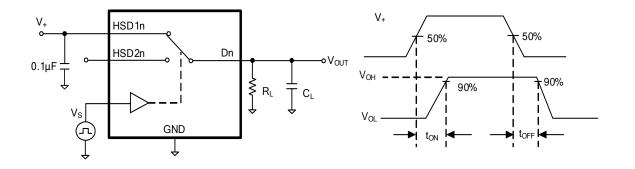


Figure 2. Turn-On (ton) and Turn-Off Time (toff)

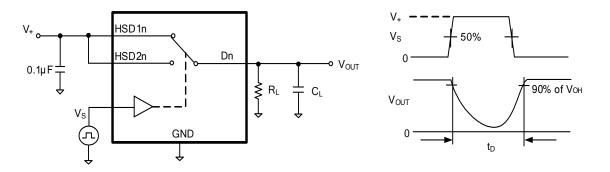
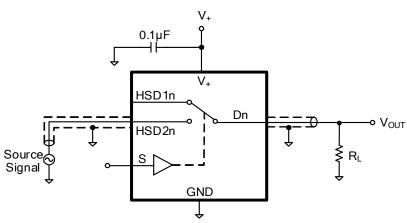
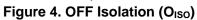
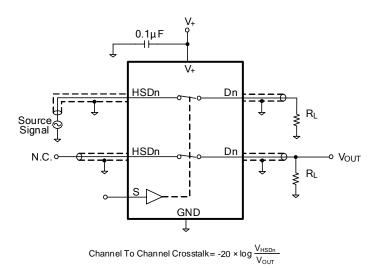


Figure 3. Break-Before-Make Time (t<sub>D</sub>)

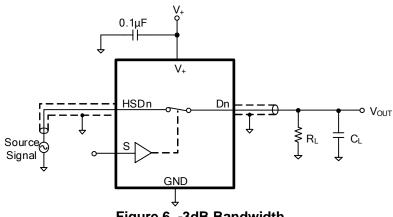




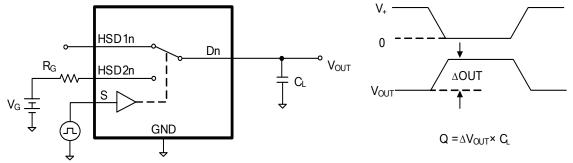




#### Figure 5. Channel-to-Channel Crosstalk











## **APPLICATION NOTES**

There are many USB applications in which the USB hubs or controllers have a limited number of USB I/Os. The RS2228 solution can effectively expand the limited USB I/Os by switching between multiple USB buses in order to interface them to a single USB hub or controller. RS2228 can also be used to connect a single controller to two USB connectors or controllers.

Design requirements of the USB 1.0, 1.1, and 2.0 standards should be followed. It is recommended that the digital control pins S and  $\overline{OE}$  be pulled up to V+ or down to GND to avoid undesired switch positions that could result from the floating pin.

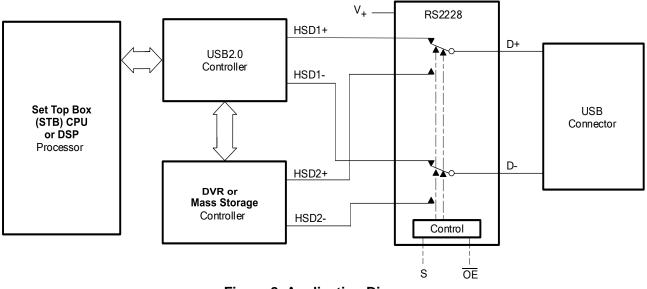
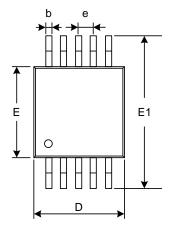
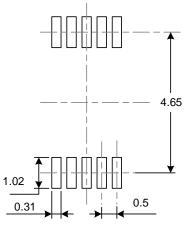


Figure 8. Application Diagram

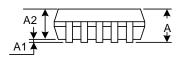


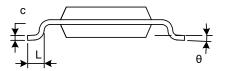
# PACKAGE OUTLINE DIMENSIONS MSOP10





RECOMMENDED LAND PATTERN (Unit: mm)



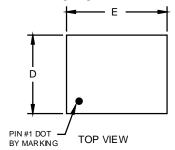


Symbol	Dimensions	n Millimeters	Dimensions In Inches			
	Min	Мах	Min	Max		
A	0.820	1.100	0.032	0.043		
A1	0.020	0.150	0.001	0.006		
A2	0.750	0.950	0.030	0.037		
b	0.180	0.280	0.007	0.011		
с	0.090	0.230	0.004	0.009		
D	2.900	3.100	0.114	0.122		
е	0.50(	BSC)	0.020	0.020(BSC)		
E	2.900	3.100	0.114	0.122		
E1	4.750	5.050	0.187	0.199		
L	0.400	0.800	0.016	0.031		
θ	0°	6°	0°	6°		



#### UQFN1.4X1.8-10

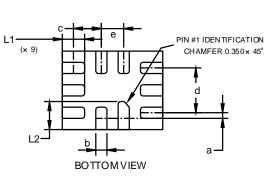
₽ A

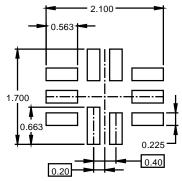


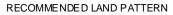
SIDE VIEW

A2

A1-





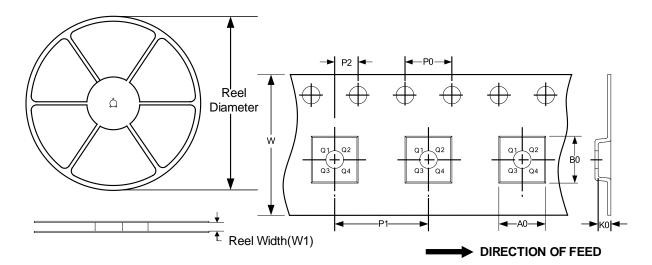


Symbol	Dimensions	In Millimeters	Dimensions In Inches			
	Min	Мах	Min	Мах		
A	0.500	0.600	0.020	0.024		
A1	0.000	0.050	0.000	0.002		
A2	0.203	B REF	0.008	B REF		
а	0.050	0.150	0.002	0.006		
b	0.150	0.250	0.006	0.010		
с	0.450	0.550	0.018	0.022		
d	0.800	) REF	0.031	0.031 REF		
D	1.350	1.450	0.053	0.057		
E	1.750	1.850	0.069	0.073		
е	0.400	) TYP	0.016	0.016 TYP		
L1	0.350	0.450	0.014	0.018		
L2	0.450	0.550	0.018	0.022		



### TAPE AND REEL INFORMATION REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

Package Type	Reel Diameter	Reel Width(mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadran t
MSOP10	13"	12.4	5.20	3.30	1.20	4.0	8.0	2.0	12.0	Q1
UQFN1.4X1.8-10	7"	9.0	1.60	2.00	0.85	4.0	4.0	2.0	8.0	Q1

#### **KEY PARAMETER LIST OF TAPE AND REEL**